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	No.: Date:	FCC-K-HTS-0003 /14 2023. 1. 24
	Date.	2023. 1. 24
Data	sheet	
Title: CHIP FUSE; RECTA	NGULAR TY	PE
Style: FCC10,16,20,32, FF	IC10,16,20,32	
	PLIANCE ITEN Antimony Fre	
	5% ithin 2 year from shipm olderability shall be sa tained in this data sh s or a Purchasing Sp	tisfied. neet are subject to change at any ecification for any quality
	釜屋電 KAMAYA	機株式會社 ELECTRIC CO., LTD. Hokkaido Research Center Approval by: T. Sannomiya Drawing by: M. Shibuya

No:	FCC-K-HTS-0003	/14
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Title:	CHIP FUSES; RECTANGULAR TYPE
	FCC10.16.20.32, FHC10.16.20.32

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1. Scope

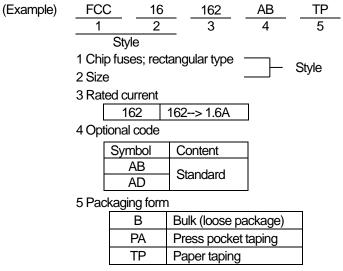
1.1 This data sheet covers the detail requirements for chip fuses; rectangular type, style of FCC10,16,20,32, FHC10,16,20,32.

1.2 Applicable documents

UL248–1–2000 Low–Voltage Fuses–Part1: General Requirements UL248–14–2000 Low–Voltage Fuses–Part14: Supplemental Fuses CSA C22.2 No.248.1–2000 Low–Voltage Fuses–Part1: General Requirements CSA C22.2 No.248.14–2000 Low–Voltage Fuses–Part14: Supplemental Fuses IEC60127–1 Miniature fuses–part 1: Definitions for miniature fuses and general requirements for miniature fuse–links IEC60127–4 Miniature fuses–Part4: Universal modular fuse–links (UMF)

2. Classification

Type designation shall be the following form.



3. Safety standard approval

• UL248-1 and UL248-14

• CSA C22.2, No. 248.1–00 and CSA C22.2, No. 248.14–00 The file number to be designated by UL and C–UL shall be as follows: E176847

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Title: CHIP FUSES; RECTANGULAR TYPE FCC10,16,20,32, FHC10,16,20,32

The ratings shall be in accordance with Table-1.

4.1 Optional code: AB

4. Rating

				Table-	-1(1)			
State	Rated current		Internal resistance value	Rated voltage	Breaking	Time / cu	rrent characteristic	
Style	Symbol	(A)	Marking symbol	(m Ω max.)	(V)	capacity (A)	Current	Pre-arcing time
	201	0.2	Z	2400				
	251	0.25	С	1000				
	321	0.315	D	750				
	401	0.4	E	620				
	501	0.5	F	340				
FCC10	631	0.63		290	DC30			
FCCIU	751	0.75	Α	220	DC30	35	200%	Famov
	801	0.8	K	210		30	200%	5 s max.
	102	1.0	L	150				
	132	1.25	М	120				
	152	1.5	Н	100				
	162	1.6	N	90				
FHC10	202	2.0	S	55	DC24			
FICIU	252	2.5	Т	40	DC24			
	201	0.2	ZB	ZB 3,200				
	251	0.25	CB	1,800				5 s max.
	321	0.315	DB	1,000			35 200%	
	401	0.4	EB	750				
	501	0.5	FB	330				
	631	0.63	IB	280				
FCC16	751	0.75	AB	210	DC36	25		
	801	0.8	KB	200				
	102	1.0	LB	130				
	132	1.25	MB	110				
	152	1.5	HB	95				
	162	1.6	NB	85				
	202	2.0	SB	70				
FHC16	252	2.5	TB	40	DC32			
	501	0.5	FB	330				
	631	0.63	IB	270				
	801	0.8	KB	190				
FCC20	102	1.0	LB	130	DC50	50	200%	5 s max.
	132	1.25	MB	100			20070	o o max.
	162	1.6	NB	80				
	202	2.0	SB	65				
FHC20	252	2.5	TB	40	DC32			

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4.2 Optional code: AD

	п	atad aurra	nt	Table- Internal	Rated	Procking	Time / cirr	rront characteristic		
Style	Rated current		resistance value	voltage	Breaking capacity	Time / current characteristic				
	Symbol	(A)	Marking symbol	(m Ω max.)	(V)	(A)	Current	Pre-arcing time		
	151	0.15	0	2700	DC32					
	201	0.2	O Z	1000						
	251	0.25	С	750						
	321	0.315	D	620						
FCC10	401	0.4	E	340						
FUCIU	501	0.5	F	290	DC30					
	631	0.63		210						
	801	0.8	K	150		35	250%	5 s max.		
	102	1.0	L	120						
	132	1.25	М	90						
	162	1.6	N	55						
	202	2.0	S	40	DC24					
FHC10	252	2.5	Т	36						
	302	3.0	R	30						
	322	3.15	U	26						
	151	0.15	OD	4000	DC50					
		0.2	ZD	1800						
-	251	0.25	CD	1000						
	321	0.315	DD	750						
	401		330							
	501	0.5	FD	280						
FCC16	631	0.63	ID	200	DC36	DC36	DC36			
	801	0.8	KD	130		05	250% 5 s max.	5 s may		
	102	1.0	LD	110		35		5 s max.		
	132	1.25	MD	85						
	162	1.6	ND	70						
	202	2.0	SD	55						
	252	2.5	TD	45	DC32					
	322	3.15	UD	26						
FHC16	352	3.5	VD	22	DC24					
	402	4.0	XD	19						
	401	0.4	401	330						
	501	0.5	501	270						
	631	0.63	631	190						
	801	0.8	801	130						
FCC20	102	1.0	102	100	DC50					
	132	1.25	132	80		FO	2500/	5 c mov		
	162	1.6	162	65		50	250%	5 s max.		
	202	2.0	202	55						
	252	2.5	252	40						
	322	3.15	UD	26	DC32					
FHC20	402	4.0	XD	19						
	502	5.0	YD	14	DC24					

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				Table	⊢1(3)				
Stude	R	ated curre	nt	Internal resistance value	Rated	Breaking	Time / current characteristic		
Style	Symbol	(A)	Marking symbol	(m Ω max.)	voltage (V)	capacity (A)	Current	Pre-arcing time	
	201	0.2	201	1800					
	251	0.25	251	1000					
	321	0.315	321	750					
	401	0.4	401	350					
	501	0.5	501	295	DC64	DC64			
	631	0.63	631	200					
FCC32	801	0.8	801	140					
	102	1.0	102	110		50	250%	5 s max.	
	132	1.25	132	85		50	23070	5 5 max.	
	152	1.5	152	78					
	162	1.6	162	75					
	202	2.0	202	65					
	252	2.5	252	45					
	322	3.15	UD	26					
FHC32	402	4.0	XD	19	DC32				
	502	5.0	YD	14					

4.3 Working temperature range: -55 to +125(°C)

5. Packaging form

The standard packaging form shall be in accordance with Table–2.

		lable	-2	
Symbol	Pac	kaging form	Standard packaging quantity / units	Application
В	Bulk (loose package)		1,000 pcs.	FCC10,16,20,32, FHC10,16,20,32
PA	Press pocket taping (paper taping)	8mm width, 2mm pitches	10,000 pcs.	FCC10, FHC10
TP	Paper taping	8mm width, 4mm pitches	5,000 pcs.	FCC16,20,32, FHC16,20,32

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Title: CHIP FUSES; RECTANGULAR TYPE FCC10,16,20,32, FHC10,16,20,32

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6. Dimensions

6.1 The resistor shall be of the design and physical dimensions in accordance with Figure–1 and Table–3.

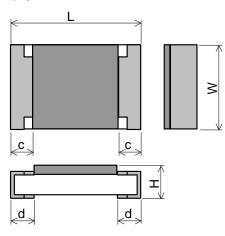


Figure-1

		Table-3			Unit:mm
Style	L	W	Н	С	d
FCC10, FHC10	1.0±0.05	0.5±0.05	0.4±0.05	0.2±0.1	0.25±0.10
FCC16, FHC16	1.6 <u>±</u> 0.1	0.8 +0.15	0.45±0.10	0.3±0.15	0.3 <u>+</u> 0.1
FCC20, FHC20	2.0±0.1	1.25±0.10	0.6±0.1	0.4±0.2	0.4 <u>+</u> 0.2
FCC32	3.2+0.2	1 6 0 15	0.6±0.1	0.5±0.25	0.5±0.25
FHC32	3.2±0.2	1.6±0.15	0.65±0.10	0.0±0.25	0.0±0.25

6.2 Net weight (Reference)

Style	Net weight(mg)
FCC10, FHC10	0.8
FCC16, FHC16	2
FCC20, FHC20	6
FCC32	10
FHC32	11

7. Marking

The Marking symbol of Sub– clause 4.1 shall be marked on over coat side. (Example)

Optional code	Marking symbol	Content
	N	FCC10 162 AB
	Т	FHC10 252 AB
ΔR	SB	FCC16 202 AB
	TB	FHC16 252 AB
	SB	FCC20 202 AB
	TB	FHC20 252 AB
	Ν	FCC10 162 AD
	U	FHC10 322 AD
	ND	FCC16 162 AD
٩٨	UD	FHC16 322 AD
AD	162	FCC20 162 AD
	UD	FHC20 322 AD
	162	FCC32 162 AD
	UD	FHC32 322 AD
	Optional code AB AD	AB AB N T SB TB SB TB N U ND AD UD 162 UD 162

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	FCC10.16.20.32, FHC10.16.20.32

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8. Performance

8.1 Unless otherwise specified, the standard range of atmospheric conditions for tests is as follows; Ambient temperature: 5 °C to 35 °C, Relative humidity: 45 % to 85 %, Air presser: 86 kPa to 106 kPa If there is any doubt the results, measurements shall be made within the following:

Ambient temperature: 20 °C ± 2 °C, Relative humidity: 60 % to 70 %, Air presser: 86 kPa to 106 kPa 8.2 The performance shall be satisfied in Table-4.

	_	Table-4(1)			
No.	Test items	Condition of test	Performance requirements		
1	Temperature rise	The fuse shall be mounted on the test substrate as shown in Figure–2. Measurement temp.: 10 °C to 30 °C Test current: Rated current The temperature at the hottest point on the surface of the fuse shall be measured after temperature equilibrium has been attained.	75 °C max.		
2	Current carrying capacity	The fuse shall be mounted on the test substrate as shown in Figure–2. Test current: 110 % of Rated current Test temp.: 70 °C \pm 2 °C Test period: 1h	Without opening		
3	Time / current characteristic	The fuse shall be mounted on the test substrate as shown in Figure–2. Test current shall be applied for continuously.	Optional codeCurrent re-arcing timeAB200%5 s max.AD250%5 s max.		
4	Terminal bond strength of the face plating	JIS C 60068-2-21 Ue1 The fuse shall be mounted on the test substrate as shown in Figure–2. Bending value: 3 mm (Among the fulcrums: 90 mm) Duration: 10 s \pm 1 s	Change of internal resistance: ±3% No evidence of mechanical damage.		
5	Resistance to soldering heat	Test by a piece. Temp. of solder bath: $260 ^{\circ}\text{C} \pm 5 ^{\circ}\text{C}$ Immersion time: $10 \text{ s} \pm 1 \text{ s}$ After immersion into solder, leaving the room temp. for 1h or more, and then measure the internal resistance.	Change of internal resistance: ±10% No evidence of appearance damage		
		 Reflow soldering Pre-heating: 150 °C ~ 180 °C, 120 s max. Peak: 260 °C ± 5 °C, 10 s max. Refrow cycle: 2 times After immersion into solder, leaving the room temp. for 1h or more, and then measure the internal resistance. 			
6	Solderability	JIS C 60068-2-58 Test by a piece Flux: Rosin–Methanol Temp. of solder: bath: 235 °C \pm 5 °C Immersion time: 2 s \pm 0.5 s	The surface of terminal immersed shall be min. of 95 % covered with a new coating of solder.		

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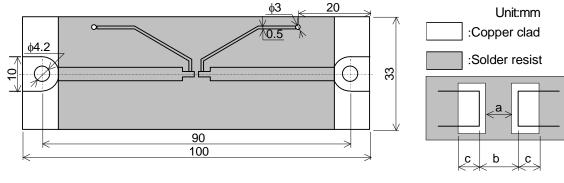
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		Table-4(2)			
No.	Test items	Condition of test	Performance requirements		
7	Rapid change temperature	JIS C 60068-2-14 Na The fuse shall be mounted on the test substrate as shown in Figure–2. Lower temperature: –55 °C Upper temperature: +125 °C Duration of exposure at each temperature: 30 min.	Change of internal resistance: ±10% No evidence of appearance damage		
8	Endurance test	Number of cycles: 5 cyclesThe fuse shall be mounted on the test substrate as shown in Figure-2.Test condition: Nominal ambient temp. and Relative humidity.Test potential:1. Cycle of 1 h "ON" and 15 min. "OFF" at 1.05 times rated current for 100 cycles.2. After above the test , 1.25 times rated current for 1h.	The voltage drop across the fuse after the test shall not have increased by more than 10 % of the value measured before test.		

9. Test substrate



Style	Α	b	С
FCC10, FHC10	0.3	0.6	0.65
FCC16, FHC16	0.6	1.0	0.5
FCC20, FHC20	0.9	1.3	0.7
FCC32, FHC32	1.8	2.2	0.85

Figure-2 FCC, FHC TEST SUBSTRATE

Remark 1). Material: Epoxide woven glass Thickness: 1. 6mm Thickness of copper clad: 0. 035mm

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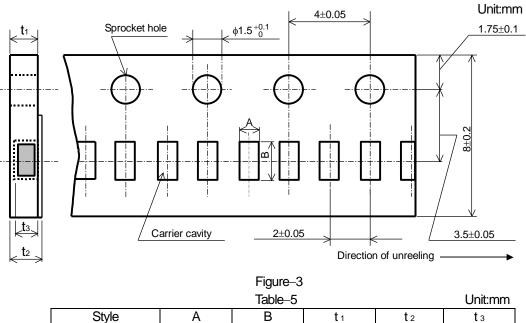
10. Taping

10.1 Applicable documents JIS C 0806–3: 2014, EIAJ ET–7200C: 2010

10.2 Taping dimensions

10.2.1 Press pocket taping(8mm width, 2mm pitches)

Taping dimensions shall be in accordance with Figure-3 and Table-5.



1.15±0.1

0.6±0.05

0.7max

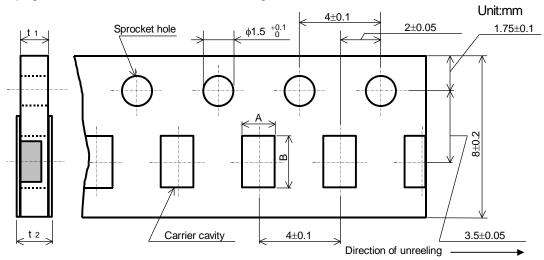
0.5±0.05

10.2.2 Paper taping (8mm width, 4mm pitches)

FCC10, FHC10

Taping dimensions shall be in accordance with Figure-4 and Table-6.

0.65±0.1



	Figu	ıre 4		
	Tab	e-6		Unit:mm
Style	A	В	t 1	t 2
FCC16, FHC16	1.15±0.15	1.9±0.2	0.6±0.1	0.8 max.
FCC20, FHC20	1.65±0.15	2.5±0.2	0.8±0.1	1.0 mov
FCC32, FHC32	2.0±0.15	3.6±0.2	0.0±0.1	1.0 max.

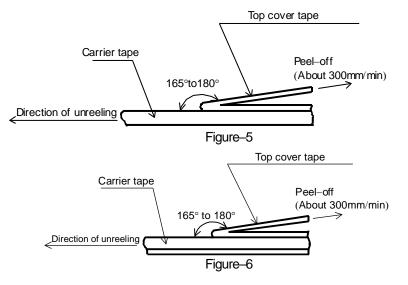
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- 1). The cover tapes shall not cover the sprocket holes.
- 2). Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following FCC10, FHC10:Figure-5,FCC16,20,32, FHC16,20,32 : Figure-6.
- 6). When the tape is bent with the minimum radius for 25 mm, the tape shall not be damaged and the components shall maintain their position and orientation in the tape.
- 7). In no case shall there be two or more consecutive components missing.

The maximum number of missing components shall be one or 0.1%, whichever is greater.

8). The fuses shall be faced to upward at the over coating side in the carrier cavity.



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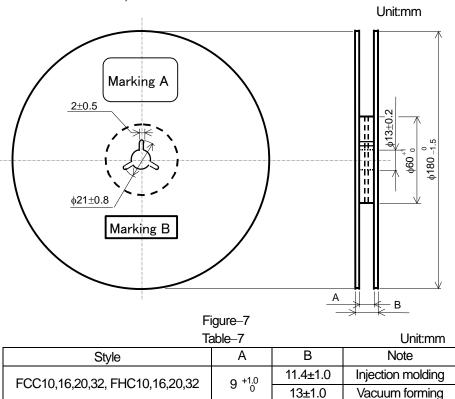
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10.3 Reel dimension

Reel dimensions shall be in accordance with the following Figure-7 and Table-7.

Plastic reel (Based on EIAJ ET-7200C)



Note: Marking label shall be marked on a place of Marking A or two place of marking A and B.

10.4 Leader and trailer tape.

(Example)

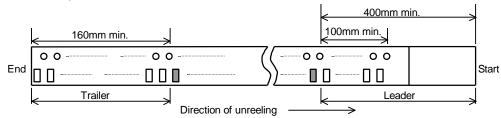


Figure-8

11. Marking on package

The label of a minimum package shall be legibly marked with follows.

11.1 Marking A

(1) Classification (Style, Rated current, Optional code, Packaging form) (2) Quantity (3) Lot number

(5) Manufacturer's name or trade mark (6) UL and /or C–UL recognized component mark (7) Others

11.2 Marking B (KAMAYA Control label)

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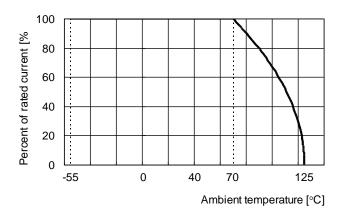
12. Recommended Derating for Rated Current

•Nominal Derating

Option Code AB: Nominal Derating \leq 70% of Rated Current Option Code AD: Nominal Derating \leq 80% of Rated Current

•Temperature Derating

Please refer to the following graph regarding the current derating value for ambient temperature.



- Ex.) If Optional code: AB (Rated Current:1.0A) is used under ambient temperature 70°C Kamaya recommends, less than the current value derated as below,
 Rated Current: 1.0A × (Nominal Derating : 70% × Temperature Derating : 100%) =0.7A
 - If Optional code: AD (Rated Current:1.0A) is used under ambient temperature 70°C Kamaya recommends, less than the current value derated as below, Rated Current: 1.0A × (Nominal Derating : 80% × Temperature Derating : 100%) =0.8A

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